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DECLARATION AND POWER OF ATTORN FOR PATENT APPLICATION	EY

Attorney	Docket	No.	

DECEMENT ADDITION	
FOR PATENT APPLICATION As a below named inventor, I hereby declare that: my that I verily believe that I am the original transfer in the control of the con	1'- 070 25
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	nost office address and citizens in the
that m	v residence, post office - cc - nlv one name is listed
I hareby declare mai. m.	d cole inventor (II only one harry
and inventor, I liercy down	inal first and sole involtes (invention entitled:
As a below named inventor, I hereby declare that: my stated next to my name; that I verily believe that I am the original below) or a joint inventor (if plural inventors a SEMICONDUCTOR DEVICE AND METHOD FOR FACE AND METHOD FACE AND METHO	of the invention
that I verily believe that I am	named below) of the appointment of
and inventors	are names the specimenters
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or a joint inventor (* - * ACCHOD FOR FA	ABRICATIO
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[]	The specification was filed on and was assigned Serial No (if known)
	and was amended on(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof, or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application, and that no application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application by me or my legal representatives or assigns, except as foreign to the United States of America prior to this application by me or my legal representatives or assigns, except as follows:

follows:

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and checked at right:

I hereby claim folding par- for patent or inventor's certificate	listed below and checked at right.	Priority Claimed Yes No
Prior Foreign Application(s) (Number) 11-353104	(Country) (Month/Day/Year Filed) Japan 12/13/1999	X
	Inventor's Certificate filed more	than 12 months prior to

All foreign applications, if any, for any Patent or Inventor's Certificate filed more than 12 months prior to the filing date of this application:

All foreign applications, the filing date of this application:		Date of Filing (Month/Day/Year)
Country	Application No.	

r. 1 dan. 3 'n. === N. W. W. Marrie

I hereby claim the benefit under Title 35, United States Code, § 119(e) or § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not application(s) used octow and, insoral as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

States Code, § 112, I acknowled between the filling date	
States Code, § 112, I acknowledge the filing date of this application: International filing date of this application: Status: patented, pending, abandor	ned
international filing date Status: patement, pure Status: patement, pure grant filing Date	
Application Serial No.	
ares to prosecute this application and/or any international a	pplication
acoute this application and/or any international	-

I hereby appoint the following attorneys to prosecute this application and/or any international application and to transact all business in the Patent and Trademark Office connected therewith:

Daniel W. Sixbey, (Reg. No. 20,932) Charles M. Leedom, Jr. (Reg. No. 26,477) David S. Safran (Reg. No. 27,997) Donald R. Studebaker (Reg. No. 32,815) Tim L. Brackett (Reg. No. 36,092) Robert M. Schulman (Reg. No. 31,196)

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Send Correspondence to:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the

The undersigned hereby authorize any U.S. attorney or agent named herein to accept and follow application or any patent issued thereon. instructions from Maeda Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys or agents named

In the event of a change in the persons from herein will be so notified by the undersigned.	To APPE
herein will be so nother	Nov. 16, 2000
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RESIDENCE (City, State & Country)	<u> </u>	CITIZENSHIP	
POST OFFICE ADDRESS (Complete Address including City	y, State & Country)		
FULL NAME OF FIFTH JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE	DATE	
RESIDENCE (City, State & Country)		CITIZENSHIP	
POST OFFICE ADDRESS (Complete Address including City	y, State & Country)		
FULL NAME OF SIXTH JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE	DATE	
RESIDENCE (City, State & Country)		CITIZENSHIP	
POST OFFICE ADDRESS (Complete Address including City, State & Country)			
FULL NAME OF SEVENTH JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE	DATE	
RESIDENCE (City, State & Country)		CITIZENSHIP	
POST OFFICE ADDRESS (Complete Address including City, State & Country)			
FULL NAME OF EIGHTH JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE	DATE	
RESIDENCE (City, State & Country)		CITIZENSHIP	
POST OFFICE ADDRESS (Complete Address including City	y, State & Country)		

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